

## Corres. and Mail



# EXPEDITED PROCEDURE AMSB Enter Per EE {18/05 AFTER-FINAL RESPONSE ART UNIT 2623

#### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Eiko Suzuki

**Examiner:** 

Brian Q. Le

Serial No.:

09/828,003

**Art Unit:** 

2623

Filed:

April 6, 2001

Docket:

14467

For:

ID RECOGNITION

Conf. No.:

APPARATUS AND ID

5196

RECOGNITION SORTER

Dated:

March 15, 2005

SYSTEM FOR

SEMICONDUCTOR WAFER

Mail Stop AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

#### AMENDMENT PURSUANT TO 37 C.F.R. § 1.116

Sir:

In response to the final Office Action dated December 15, 2004, Applicant respectfully requests under the provisions of 37 C.F.R. § 1.116 that the aboveidentified Application be amended as follows and that the Application be allowed.

### CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on March 15, 2005.

**Dated:** March 15, 2005

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